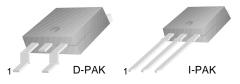


### MJD32/32C

## **General Purpose Amplifier Low Speed Switching Applications** D-PAK for Surface Mount Applications Load Formed for Surface Mount Application (No Suffix)

- Straight Lead (I-PAK, "- I" Suffix)
- Electrically Similar to Popular TIP32 and TIP32C



1.Base 2.Collector 3.Emitter

## **PNP Epitaxial Silicon Transistor**

### Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	- 40	V
	: MJD32	- 100	V
	: MJD32C		
$V_{CEO}$	Collector-Emitter Voltage	- 40	V
	: MJD32	- 100	V
	: MJD32C		
$V_{EBO}$	Emitter-Base Voltage	- 5	V
I <sub>C</sub>	Collector Current (DC)	- 3	А
I <sub>CP</sub>	Collector Current (Pulse)	- 5	А
I <sub>B</sub>	Base Current	- 1	А
P <sub>C</sub>	Collector Dissipation (T <sub>C</sub> =25°C)	15	W
	Collector Dissipation (T <sub>a</sub> =25°C)	1.56	W
T <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	- 65 ~ 150	°C

### Electrical Characteristics $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
V <sub>CFO</sub> (sus)	* Collector-Emitter Sustaining Voltage				
020	: MJD32	$I_C = -30 \text{mA}, I_B = 0$	-40		V
	: MJD32C		-100		V
I <sub>CEO</sub>	Collector Cut-off Current				
	: MJD32	$V_{CE} = -40V, I_{B} = 0$		-50	μΑ
	: MJD32C	$V_{CE} = -60V, I_{B} = 0$		-50	μΑ
I <sub>CES</sub>	Collector Cut-off Current				
	: MJD32	$V_{CE} = -40V, V_{BE} = 0$		-20	μΑ
	: MJD32C	$V_{CE} = -100V, V_{BE} = 0$		-20	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	V <sub>BE</sub> = - 5V, I <sub>C</sub> = 0		-1	mA
h <sub>FE</sub>	* DC Current Gain	$V_{CE} = -4V, I_{C} = -1A$	25		
		$V_{CE} = -4V, I_{C} = -3A$	10	50	
V <sub>CE</sub> (sat)	* Collector-Emitter Saturation Voltage	I <sub>C</sub> = - 3, I <sub>B</sub> = - 375mA		-1.2	V
V <sub>BE</sub> (on)	* Base-Emitter ON Voltage	V <sub>CE</sub> = - 4A, I <sub>C</sub> = - 3A		-1.8	V
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> = -10V, I <sub>C</sub> = - 500mA	3		MHz

<sup>\*</sup> Pulse Test: PW≤300μs, Duty Cycle≤2%

# **Typical Characteristics**

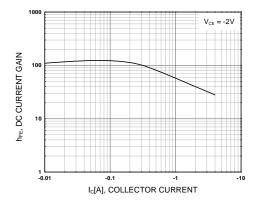


Figure 1. DC current Gain

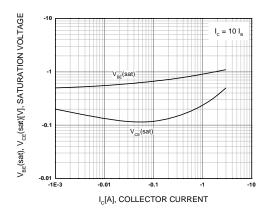


Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

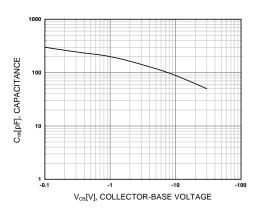


Figure 3. Collector Capacitance

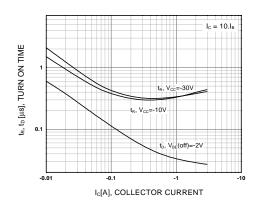


Figure 4. Turn On Time

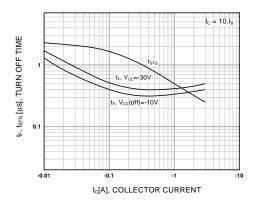


Figure 5. Turn Off Time

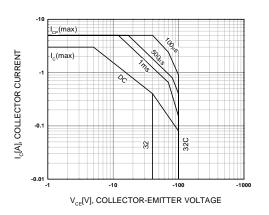


Figure 6. Safe Operating Area

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# Typical Characteristics (Continued)

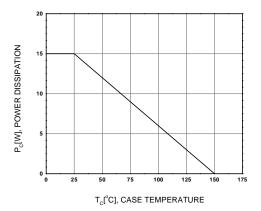
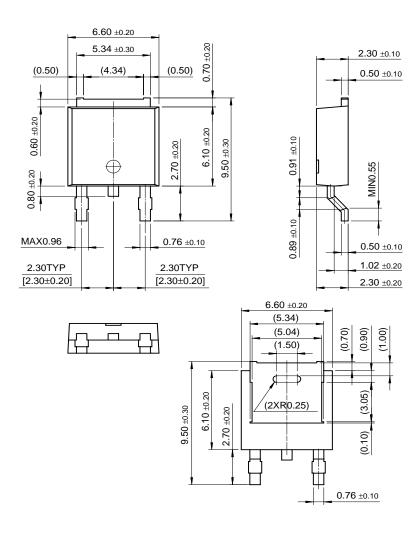


Figure 7. Power Derating

## **Package Demensions**

## D-PAK



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